

ELECTRONIC DEVICE INCLUDING HEAT DISSIPATION STRUCTURE

【ABSTRACT】

An electronic device according to various embodiments of the present disclosure may
5 include: a housing, a non-conductive support member disposed inside the housing, the support
member including a first area, a second area spaced apart from the first area, and a third area
connecting the first area and the second area; a conductive pattern part disposed over the first area
of the support member; a heat dissipation member of which at least a part is disposed to overlap
the conductive pattern part; and an antenna including a circuit board, a conductive portion, and a
10 ground portion. The conductive portion of the antenna may be disposed over the second area, the
heat dissipation member may be formed to extend from the first area to the third area, and the
ground portion of the antenna may be formed to extend from the second area to the third area so
as to be disposed in contact with at least a part of the heat dissipation member.

15 Fig. 6